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Product data sheet

1. Product profile

1.1 General description

PNP low V_{CEsat} Breakthrough In Small Signal (BISS) transistor and NPN Resistor-Equipped Transistor (RET) in a SOT457 (SC-74) small Surface-Mounted Device (SMD) plastic package.

1.2 Features

- Low V_{CEsat} (BISS) and resistor-equipped transistor in one package
- Low threshold voltage (<1 V) compared to MOSFET
- Low drive power required
- Space-saving solution
- Reduction of component count

1.3 Applications

- Supply line switches
- Battery charger switches
- High-side switches for LEDs, drivers and backlights
- Portable equipment

1.4 Quick reference data

Table 1.Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1; PNP I	ow V _{CEsat} transistor					
V _{CEO}	collector-emitter voltage	open base	-	-	-40	V
I _C	collector current		<u>[1]</u> _	-	-1	А
R _{CEsat}	collector-emitter saturation resistance	I _C = -500 mA; I _B = -50 mA	[2] _	240	340	mΩ
TR2; NPN I	resistor-equipped transistor					
V _{CEO}	collector-emitter voltage	open base	-	-	50	V
I _O	output current		-	-	100	mA
R1	bias resistor 1 (input)		1.54	2.2	2.86	kΩ
R2/R1	bias resistor ratio		0.8	1	1.2	

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.



sym036

40 V PNP BISS loadswitch

2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	emitter TR1		
2	base TR1		
3	output (collector) TR2		
4	GND (emitter) TR2		R1 R2
5	input (base) TR2		
6	collector TR1		

3. Ordering information

Table 3. Ordering information				
Type number	Package			
	Name	Description	Version	
PBLS4001D	SC-74	plastic surface-mounted package (TSOP6); 6 leads	SOT457	

4. Marking

Table 4. Marking codes	
Type number	Marking code
PBLS4001D	R1

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
TR1; PN	P low V _{CEsat} transistor				
V _{CBO}	collector-base voltage	open emitter	-	-40	V
V_{CEO}	collector-emitter voltage	open base	-	-40	V
V_{EBO}	emitter-base voltage	open collector	-	-5	V
I _C	collector current		<u>[1]</u> -	-0.7	А
			[2] _	-0.85	А
			[3] _	-1	А
I _{CM}	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	-2	А
I _B	base current		-	-0.3	А
I _{BM}	peak base current	single pulse; $t_p \le 1 \text{ ms}$	-	-1	А

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Symbol	Parameter	Conditions	Min	Max	Unit
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> -	250	mW
			[2] _	350	mW
			[3] _	400	mW
TR2; NPI	N resistor-equipped transis	stor			
V _{CBO}	collector-base voltage	open emitter	-	50	V
V _{CEO}	collector-emitter voltage	open base	-	50	V
V _{EBO}	emitter-base voltage	open collector	-	10	V
VI	input voltage				
	positive		-	+12	V
	negative		-	-10	V
I _O	output current		-	100	mA
I _{CM}	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	100	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	-	200	mW
Per devic	ce				
P _{tot}	total power dissipation		<u>[1]</u> _	400	mW
			[2] _	530	mW
			[3] _	600	mW
Тj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

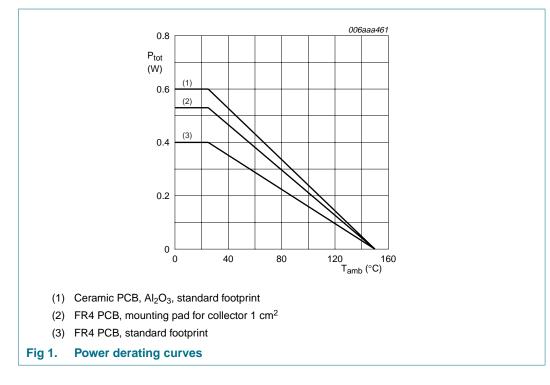
Table 5. Limiting values ...continued

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

[3] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

40 V PNP BISS loadswitch



6. Thermal characteristics

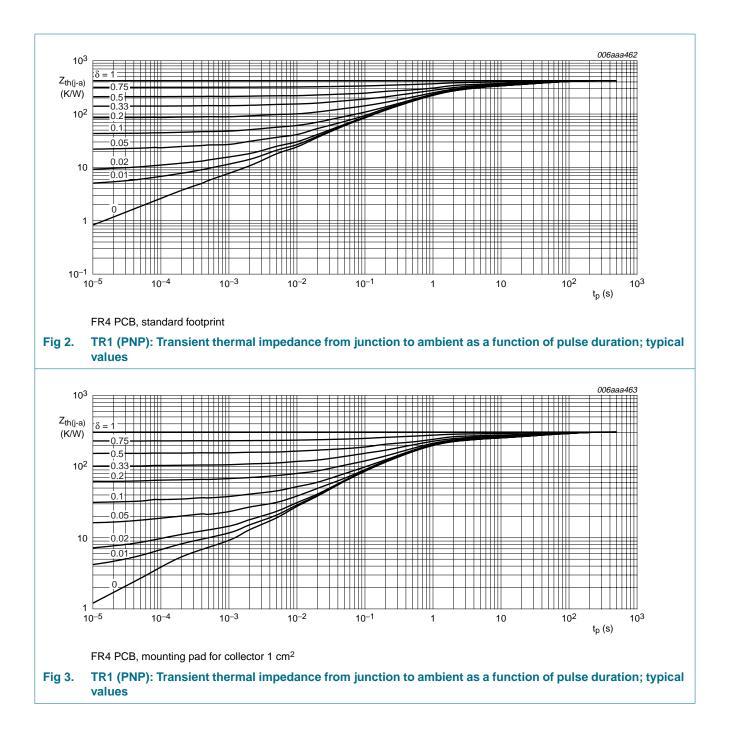
0	Demonstration		N#!	T	Marr	1.1
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per devic	e					
R _{th(j-a)}	thermal resistance from	in free air	<u>[1]</u> _	-	312	K/W
	junction to ambient		[2] _	-	236	K/W
			[3] _	-	210	K/W
Per TR1;	PNP low V _{CEsat} transistor					
R _{th(j-sp)}	thermal resistance from junction to solder point		-	-	105	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

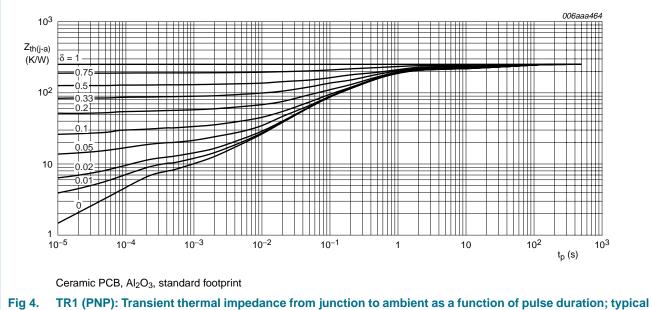
[3] Device mounted on a ceramic PCB, AI_2O_3 , standard footprint.

PBLS4001D



PBLS4001D

40 V PNP BISS loadswitch



values

7. Characteristics

Table 7.Characteristics

 $T_{amb} = 25 \circ C$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
TR1; PN	P low V _{CEsat} transistor					
I _{CBO}	collector-base cut-off	$V_{CB} = -40 \text{ V}; I_E = 0 \text{ A}$	-	-	-0.1	μΑ
	current	$\label{eq:VCB} \begin{array}{l} V_{CB} = -40 \text{ V}; \text{ I}_E = 0 \text{ A}; \\ T_j = 150 \ ^\circ\text{C} \end{array}$	-	-	-50	μA
I _{CES}	collector-emitter cut-off current	$V_{CE} = -30 \text{ V}; V_{BE} = 0 \text{ V}$	-	-	-0.1	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$	-	-	-0.1	μΑ
h _{FE}	DC current gain	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -1 \text{ mA}$	300	-	-	
		V_{CE} = -5 V; I_C = -100 mA	[1] 300	-	800	
		V_{CE} = -5 V; I _C = -500 mA	<mark>1</mark> 215	-	-	
		$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -1 \text{ A}$	<mark>[1]</mark> 150	-	-	
V _{CEsat}	collector-emitter	$I_{C} = -100 \text{ mA}; I_{B} = -1 \text{ mA}$	-	-80	-140	mV
	saturation voltage	$I_{C} = -500 \text{ mA}; I_{B} = -50 \text{ mA}$	<u>[1]</u> _	-120	-170	mV
		$I_{C} = -1 \text{ A}; I_{B} = -100 \text{ mA}$	<u>[1]</u> _	-220	-310	mV
R _{CEsat}	collector-emitter saturation resistance	$I_{C} = -500 \text{ mA}; I_{B} = -50 \text{ mA}$	<u>[1]</u> _	240	340	mΩ
V _{BEsat}	base-emitter saturation voltage	$I_{\rm C} = -1$ A; $I_{\rm B} = -50$ mA	<u>[1]</u> _	-	-1.1	V
V_{BEon}	base-emitter turn-on voltage	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -1 \text{ A}$	<u>[1]</u> _	-	-1	V

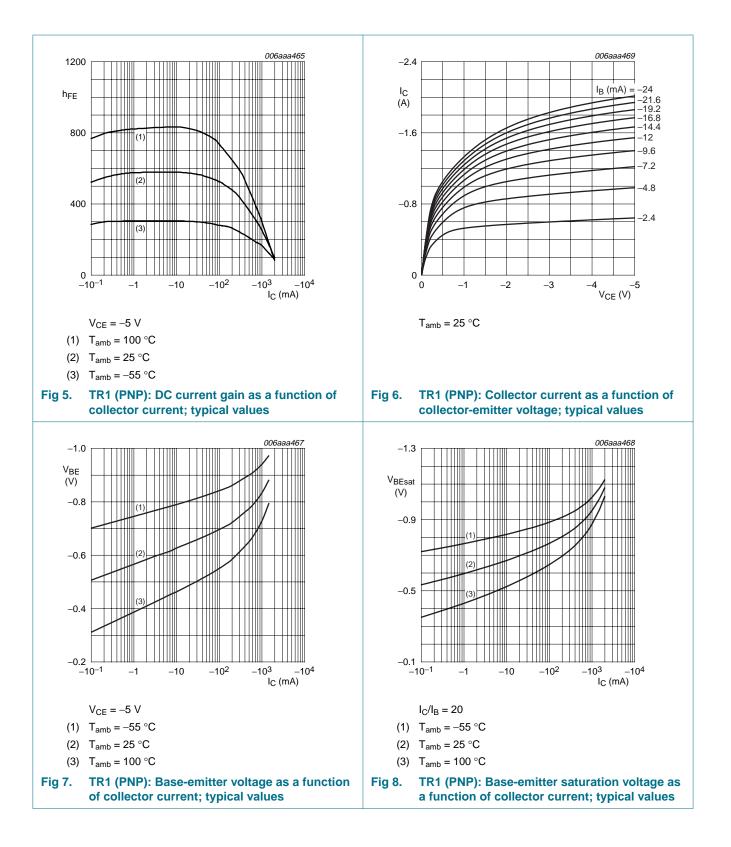
40 V PNP BISS loadswitch

$T_{amb} = 25$	°C unless otherwise sp	ecified.				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f _T	transition frequency	$I_{C} = -50 \text{ mA}; V_{CE} = -10 \text{ V};$ f = 100 MHz	150	-	-	MHz
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz	-	-	12	pF
TR2; NP	N resistor-equipped tra	ansistor				
I _{CBO}	collector-base cut-off current	$V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$	-	-	100	nA
I _{CEO}	collector-emitter	$V_{CE} = 30 \text{ V}; \text{ I}_{B} = 0 \text{ A}$	-	-	1	μA
cut-off current	$V_{CE} = 30 \text{ V}; I_B = 0 \text{ A};$ $T_j = 150 \text{ °C}$	-	-	50	μA	
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 V; I_C = 0 A$	-	-	2	mA
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 20 \text{ mA}$	30	-	-	
V _{CEsat}	collector-emitter saturation voltage	$I_{\rm C}$ = 10 mA; $I_{\rm B}$ = 0.5 mA	-	-	150	mV
V _{I(off)}	off-state input voltage	$V_{CE} = 5 \text{ V}; I_{C} = 1 \text{ mA}$	-	1.2	0.5	V
V _{I(on)}	on-state input voltage	$V_{CE} = 0.3 \text{ V}; I_{C} = 20 \text{ mA}$	2	1.6	-	V
R1	bias resistor 1 (input)		1.54	2.2	2.86	kΩ
R2/R1	bias resistor ratio		0.8	1	1.2	
C _c	collector capacitance	V_{CB} = 10 V; I_E = i_e = 0 A; f = 1 MHz	-	-	2.5	pF

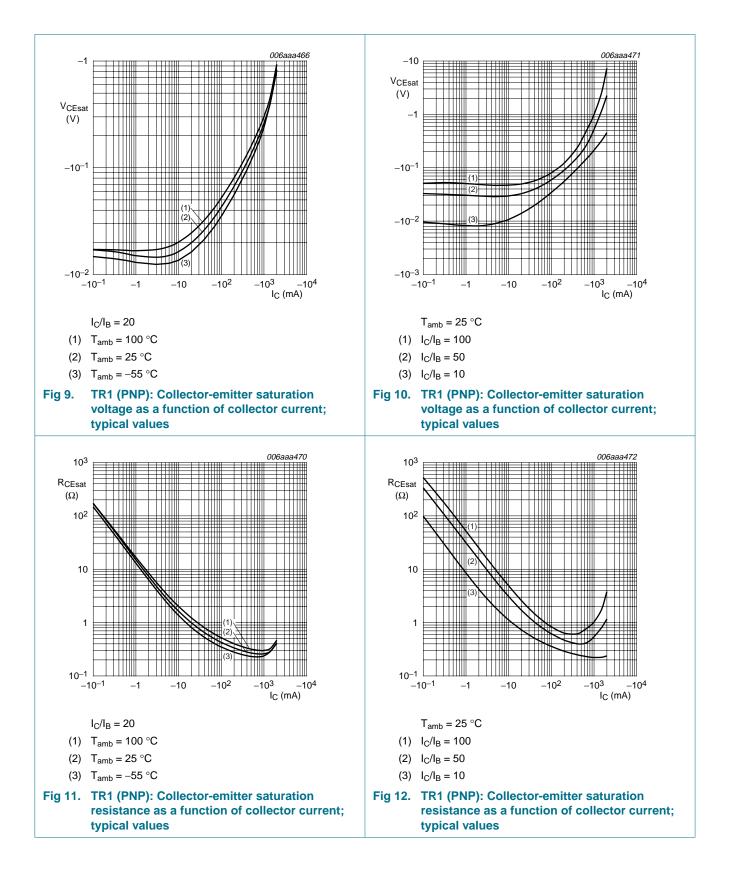
Table 7. Characteristics ...continued

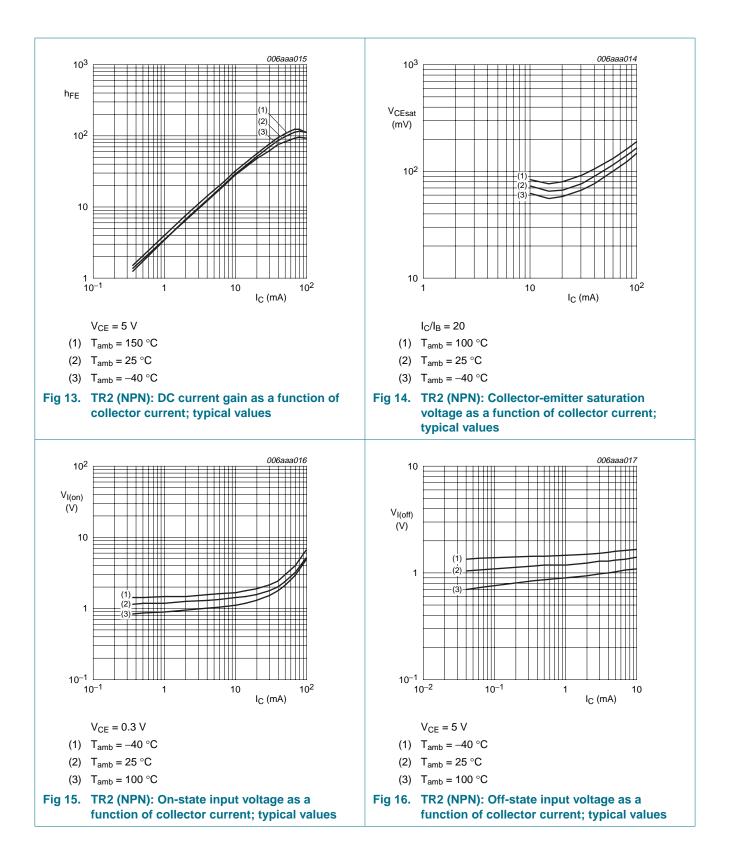
[1] Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02$.

PBLS4001D



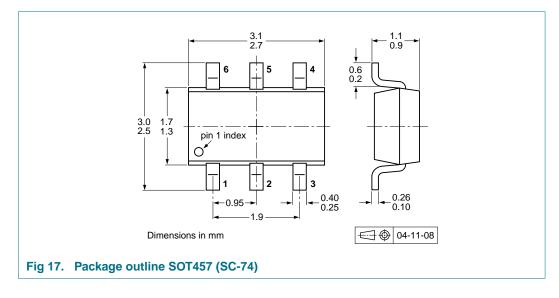
PBLS4001D





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8. Package outline



9. Packing information

Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number Package Description			Packing	g quantity	
				3000	10000
PBLS4001D	SOT457	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-135
		4 mm pitch, 8 mm tape and reel; T2	<u>[3]</u>	-125	-165

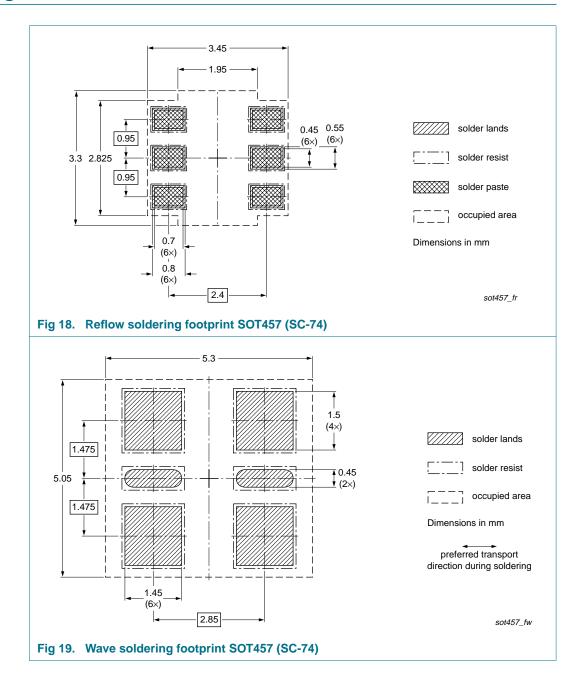
[1] For further information and the availability of packing methods, see <u>Section 13</u>.

[2] T1: normal taping

[3] T2: reverse taping

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10. Soldering



11. Revision history

Table 9. Revision hi	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PBLS4001D_3	20090105	Product data sheet	-	PBLS4001D_2
Modifications:		of this data sheet has been of NXP Semiconductors.	redesigned to comply v	vith the new identity
	 Legal texts 	have been adapted to the n	iew company name whe	ere appropriate.
	• Figure 5, 9	and <u>10</u> : amended		
	Section 12 ^c	Legal information": update	d	
PBLS4001D_2	20050705	Product data sheet	-	PBLS4001D_1
PBLS4001D_1	20041130	Objective data sheet	-	-

12. Legal information

12.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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